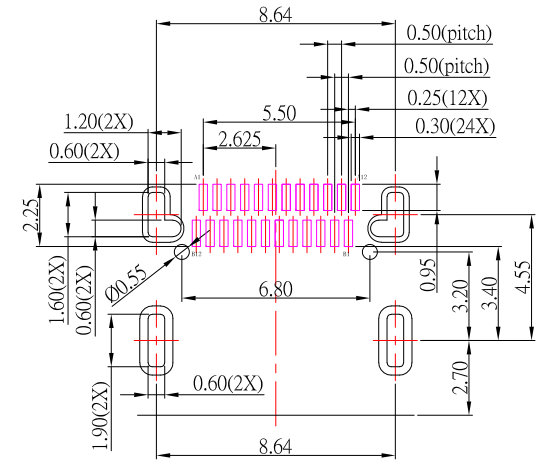
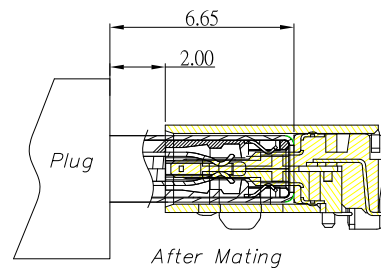




- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



PIN	Signal Name	Description	PIN	Signal Name	Description
A1	GND	Ground return	B12	GND	Ground return
A2	SSTAp1	Positive half of first SuperSpeed TX differential pair	B11	SSTAp1	Positive half of first SuperSpeed RX differential pair
A3	SSTAn1	Negative half of first SuperSpeed TX differential pair	B10	SSTAn1	Negative half of first SuperSpeed RX differential pair
A4	Vbss	Bias Power	B9	Vbss	Bias Power
A5	CC1	Configuration Channel	B8	SBR2	Sideband Use (SR0)
A6	Dp1	Positive half of the USB 2.0 differential pair-Position 1	B7	Dn2	Negative half of the USB 2.0 differential pair-Position 2
A7	Dn1	Negative half of the USB 2.0 differential pair-Position 1	B6	Dp2	Positive half of the USB 2.0 differential pair-Position 2
A8	SBR1	Sideband Use (SR0)	B5	CC2	Configuration Channel
A9	Vbss	Bias Power	B4	Vbss	Bias Power
A10	SSTRx2	Negative half of second SuperSpeed RX differential pair	B3	SSTTx2	Negative half of second SuperSpeed TX differential pair
A11	SSTRx2	Positive half of second SuperSpeed RX differential pair	B2	SSTTx2	Positive half of second SuperSpeed TX differential pair
A12	GND	Ground return	B1	GND	Ground return

				CONTACT 建倚科技股份有限公司 CONTACT TECHNOLOGY CORP. TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2 5 ~ 15 ±0.3 15 ~ 30 ±0.4 30 ~ 50 ±0.5 Angle ±0.3° 3RD. ANGEL'S  UNITS MM	DRAWN BY: DATE		MAT'L	TITLE	CONNECTOR			
					Jack Lu	04/22/26						
					CHECKED BY: DATE		FINISH	MODLE	USB 4.0 C TYPE SMT 板上雙貼有柱 外殼腳長1.60 GEN 3X2 40G			
					Jacky Chen	04/22/26						
				APPROVED BY: DATE		SCALE	1 : 1	DWG NO.	SBC-240S4D-45-S338	SIZE A4		
ITEM NO.	DESCRIPTION	DRAWN	DATE			Tony Kao	04/22/26	SHEET NO.	1 of 1	PART NO.	SBC-240S4D-45-S338	VER R